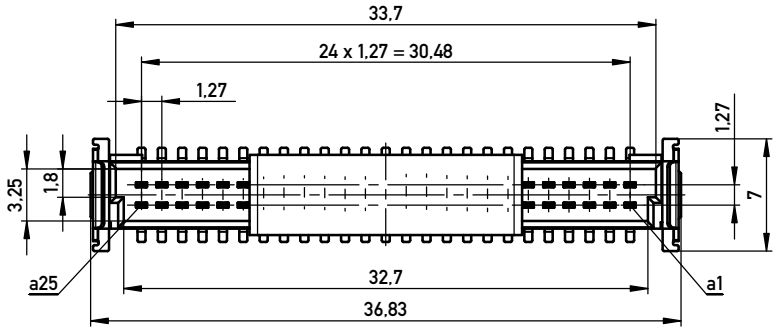
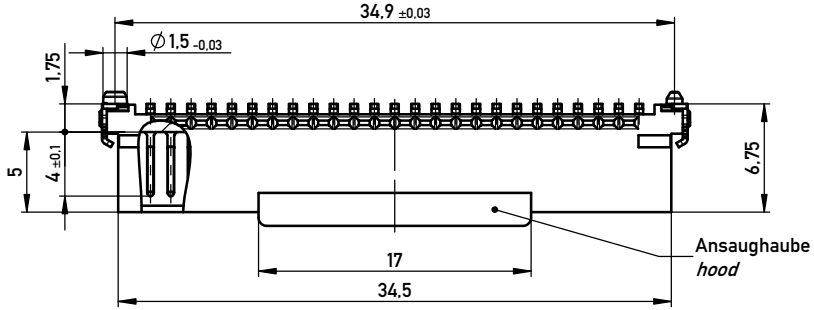
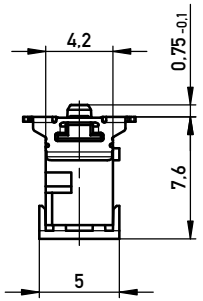


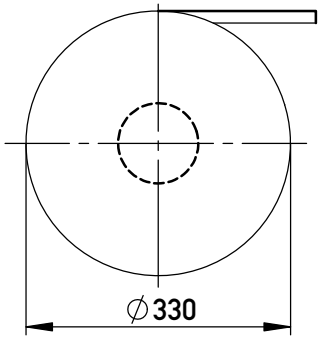

Anforderungsstufe 1
*Performance Level 1*

Kontaktbereich vergoldet
*Mating Area gold plating*

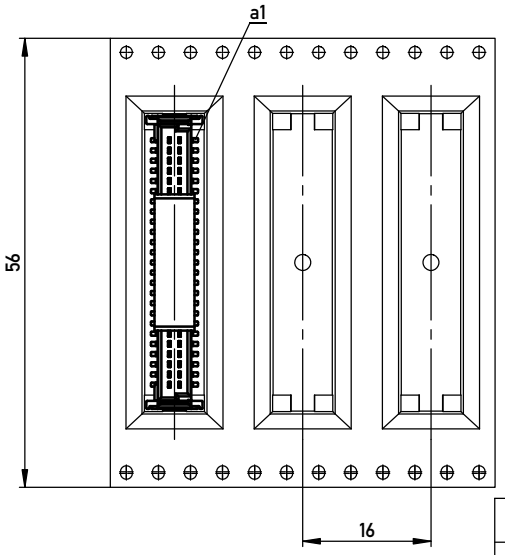
Anschlussbereich verzinnt 4-6 µm
*Terminal Area 4-6 µm tin plating*

Koplanarität der Anschlüsse ≤ 0,1 mm
*Coplanarity Area of Termination ≤ 0,1 mm*

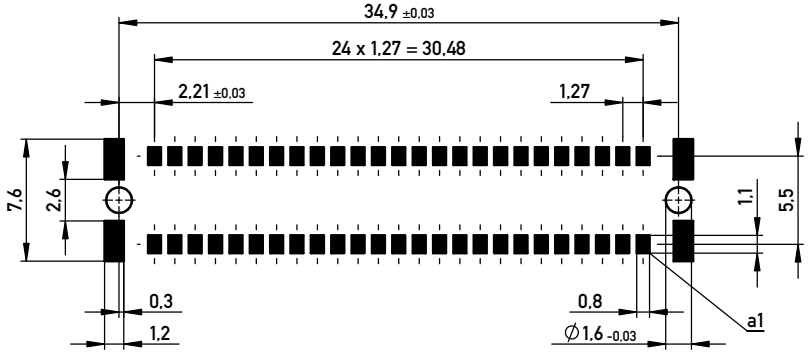
Verpackt in Gurtverpackung
*Tape on Reel Packaging*
Verpackungseinheit: 280 Stück
*Packaging unit: 280 pcs*




Abspulrichtung - *Reel off Direction*




Leiterplatten-Layout Vorschlag für SMT
*PCB-Layout Proposal for SMT*




BA 8-13 - 8mm Bauhöhe
*type 8-13 - Low Profile*

Information:

Tolerances

All Dimensions in mm

Scale 3:1

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Drawing will not be updated.

Designation
Messerl. SMC-Q 50-SMD-BA8-13
*Male SMC-Q 50-SMD-type 8-13*

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| d | | 22.07.2013 | |

Class SMCQ